

Multilayer Ceramic Chip Capacitors

CGA3E3X7S2A104M080AB



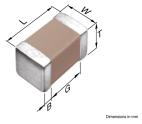






TDK item description CGA3E3X7S2A104MT****

Applications	Automotive Grade
Feature	Mid Mid Voltage (100 to 630V) AEC-Q200 AEC-Q200
Series	CGA3(1608) [EIA 0603]
Status	Production



	Size
Length(L)	1.60mm ±0.10mm
Width(W)	0.80mm ±0.10mm
Thickness(T)	0.80mm ±0.10mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.30mm Min.
Recommended Land Pattern (PA)	0.70mm to 1.00mm(Flow Soldering)
Recommended Land Pattern (PA)	0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PB)	0.80mm to 1.00mm(Flow Soldering)
Neconinended Land Lattern (LB)	0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.60mm to 0.80mm(Flow Soldering)
neconinencea Lana i accent (FC)	0.60mm to 0.80mm(Reflow Soldering)

Ele	ctrical Characteristics
Capacitance	100nF ±20%
Rated Voltage	100VDC
Temperature Characteristic	X7S(±22%)
Dissipation Factor (Max.)	5%
Insulation Resistance (Min.)	5000ΜΩ

Other		
Coldaring Mathod	Wave (Flow)	
Soldering Method	Reflow	
AEC-Q200	Yes	
Packing	Punched (Paper)Taping [180mm Reel]	
Package Quantity	4000pcs	

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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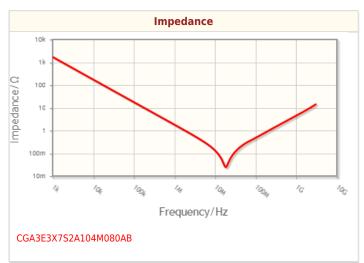


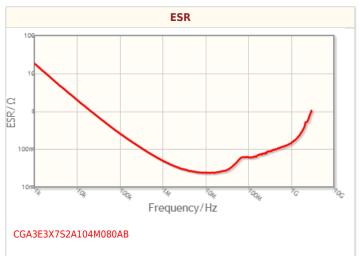


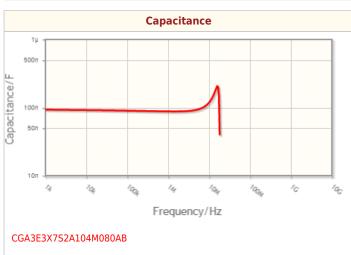




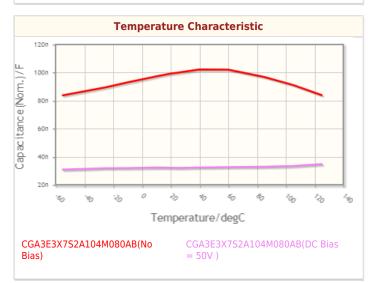
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

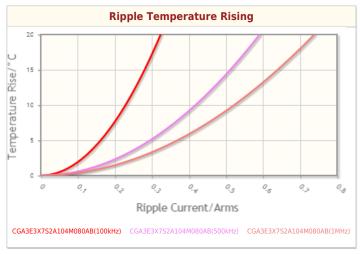












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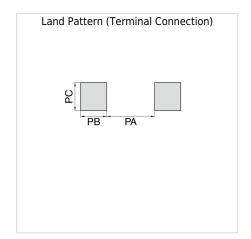








Associated Images



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